



# CAN FD in ST Powertrain Microcontroller Products

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Automotive Microcontroller Marketing

# Automotive Microcontroller Market Trend

## Next generation MCU for Powertrain

### Powertrain market trends are driving the MCU

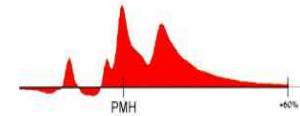
- Segregation between developing and developed markets
- Increased diversity of powertrain configurations
  - Gasoline PFI, GDI, Diesel DI, HCCI?
  - Hybrid : is coming in addition to diesel/gasoline
    - light hybrid (start/stop), mild hybrid till ability to run in zero emission mode.
  - Exhaust post treatment, turbo technologies also increase the configurations
  - Electric propulsion
- More scalable and standardized MCU products are needed from very low end cost driven derivatives to super integrated performance

# Automotive Microcontroller Market Trend

## Next generation MCU for Powertrain

### Powertrain market trends are driving the MCU

- Increased number of sensors / actuators in combustion engines for emission demanding countries
  - New types of analog acquisitions :
    - In-cylinder pressure, crank position sensor with higher precision and faster synchronization
  - Different sensors / actuator interfaces
    - SENT, PSI5, LIN
  - I/O serialization is helping to reduce MCU package pin count
    - Microsecond bus between MCU and ASSP
  - New actuators
    - Valve train electrification



# Microcontroller in Powertrain – Requirement Shift

Example: MCU requirement for 4Cylinder GDI Engine Management control

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## MCU in Y2005

### ST10F276

16Bit  
64MHz ST10 Single CPU  
MAC Unit

832Kbyte Flash Memory  
68k RAM

CAPCOM / PWM Module  
Serial Interface: 2xUSART,  
2xSPI, 2x I2C

QFP144

INNOVATION

## MCU in Y2010

### Monaco

32Bit  
80MHz PPC-Z3 Main CPU  
Floating Point Unit

1.5Mbyte Flash Memory  
94k RAM

eTPU Timer Module  
Serial Interface: 2xSCI,  
2xSPI, 2xCAN

QFP144/176

INNOVATION

## MCU in Y2015

### McKinley

32Bit  
2x200MHz Z4d Main CPU  
Floating Point Unit  
200MHz Z4d IO CPU

4Mbyte Flash Memory  
304k RAM

High-end GTM Module  
Serial Interface: 2xFlexRay,  
1xEthernet, 3xM-CAN,  
1xTT-CAN, 5xLINFlex,  
1xI2C, 7xDSPi,  
10xSENT, 3xPSI5

eQFP176/BGA292

- ~40DMIPS Performance
- 180nm Technology, ST-Rousset 8”
- ~9Mio Transistors
- Users Manual: 230pages

- ~80DMIPS Performance
- 90nm Technology, ST-Rousset 8”
- ~28Mio Transistors
- Users Manual: 800pages

- ~500DMIPS Performance
- 55nm Technology, ST-Crolles 12”
- ~106Mio Transistors
- Users Manual: 5000pages

COMPLEXITY INCREASE

# Increased Device Complexity

## Key drivers

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- New market requirements
  - Safety
  - Security
  - Multicore processing
  - SW standardization
  - New calibration concepts
  - New Networking
- Legacy or customer specific requirements
  - Peripherals / Interfaces
  - Timer modules

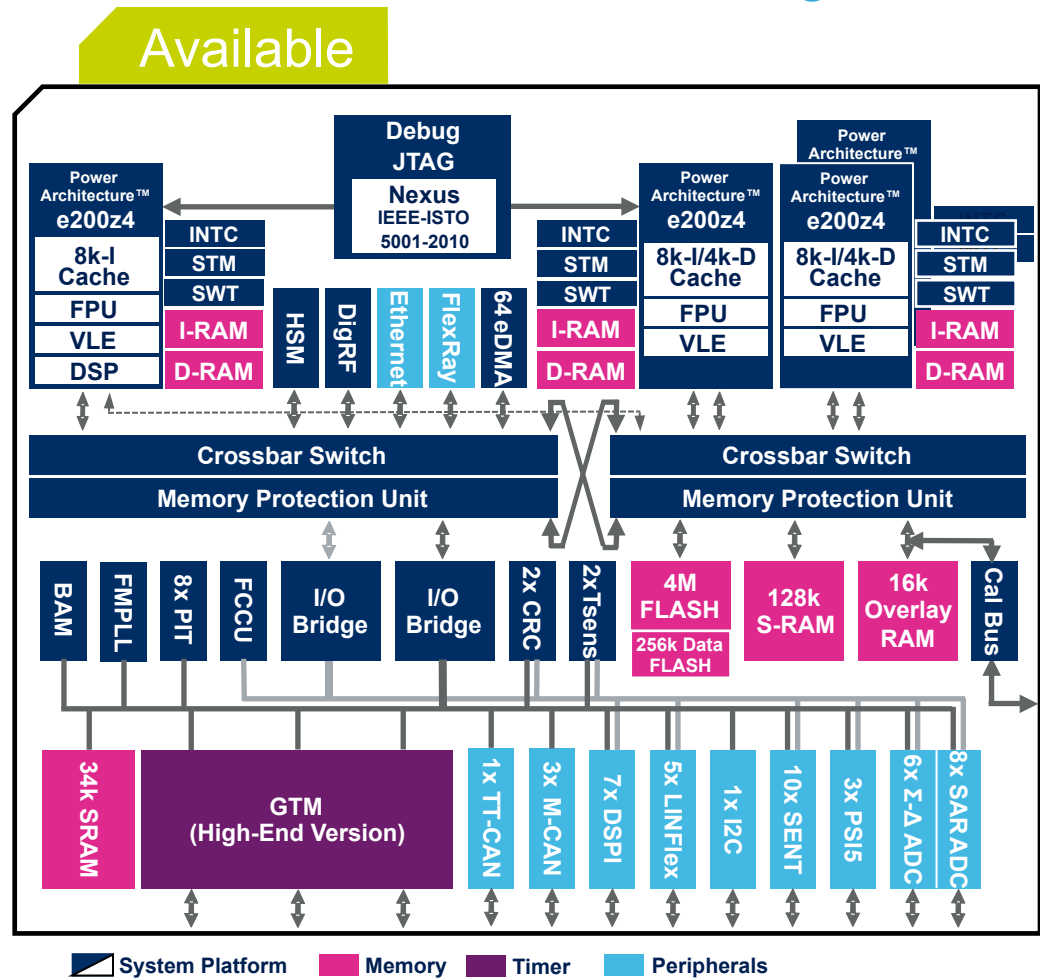
# Example: McKinley – 4M SPC57EM80

## Block Diagram

### I/O

- Generic Timer Module (High-End Version)
  - 32 Inputs, 88 Outputs
- Dual Channel FlexRay (10MB/s), 64 buffers
- 3 x M-CAN (with full FD CAN support)
- 1 x TT-CAN
- 5 x LINFlex
- 7 x DSPI including 2 x  $\mu$ SB
- 1 x Ethernet
- 1 x I2C
- 10 x SENT
- 3 x PSI5
- 1x LFAST (Interprocessor bus)

- Most of the peripherals are small, but the added device complexity results in large die size
- Effort has to be standardized so not to add additional device complexity when going for higher performance
- FD CAN is a good example



# FD CAN advantages

## CAN Evolution

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- Close the bandwidth gap between CAN and other high bandwidth IF's
- Avoid increased system cost
- Use existing network topologies on physical layer
- Provide an upgrade path so not a totally new protocol



**can**<sup>FD</sup>

# CAN improvements

- To overcome the current data rate limitation on classical CAN networks the CAN spec can be changed in two directions:
  - Increase the baud rate
  - Increase the number of data bytes per CAN frame
- Stay compatible with today technology on CAN physical layer
  - Existing CAN transceiver shall be compatible with future improvements on CAN spec

The Robert Bosch GmbH has translated these requirements into the new specification „**CAN with Flexible Data-Rate** “ called CAN FD



- CAN FD is a good approach to deal with increased bandwidth requirements in Automotive networks while maintaining existing protocols
- CAN FD could close the gap between standard CAN and higher bandwidth protocols (e.g. FlexRay)
  - Will depend on the overall device and tool availability
- Low effort to migrate to CAN FD, rather than implementing a new standard
- STMicroelectronics has implemented CAN FD in new powertrain devices



Thank You !